

Features

- 1206 1.0mm SMD LED
- High Brightness
- AlInGaP / InGaN Technology
- Side View
- High reliability
- Clear Lens

Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

Description

The IN-S126TBSRGB is a popular 1206 side view RGB package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

Recommended Solder Pattern

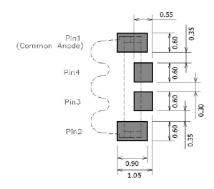
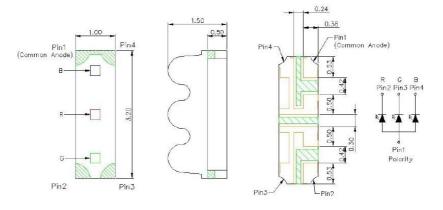


Figure 1. IN-S126TBSRGB Solder Pattern

Package Dimensions in mm



Notes.

- All dimensions are in millimeters.
- 2. Tolerance is ± 0.10 mm unless otherwise noted

Figure 2. IN-S126TBSRGB Package Dimensions



Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	T _{OP} (°C)	T _{ST} (°C)	
	Red	45	20	60		-30~+85		
IN-S126TBSRGB	Green	56	20	60	5		-40~+90	
	Blue	60	20	60				

Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Electrical Characteristics $T_A = 25\%$ (Note 1)

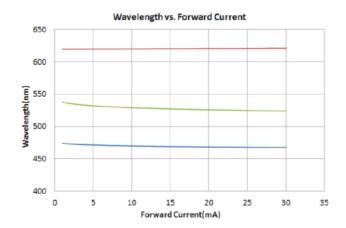
	Emission	I _F	V _F (V)		λ(nm)			Viewing Angle	l* _V (mcd)
Product	Color	(mA)	typ.	max	λ_{D}	$\lambda_{ extsf{P}}$	Δλ	2 0 1/2	typ.
	Red	20	2.0	2.4	620	630	20	110	950
IN-S126TBSRGB	Green	20	3.0	3.4	526	518	30	110	1500
	Blue	20	3.0	3.4	460	463	20	110	330

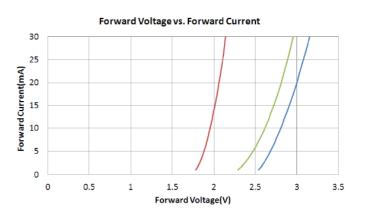
Notes

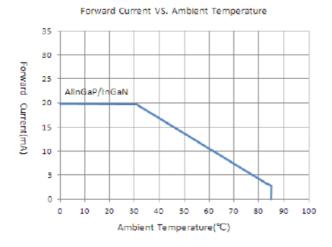
1. Performance guaranteed only under conditions listed in above tables.

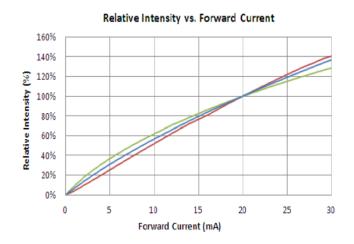


Typical Characteristic Curves





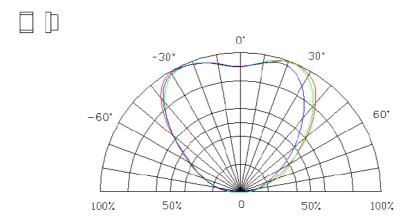






Typical Characteristic Curves – Radiation Pattern

Directive Characteristics

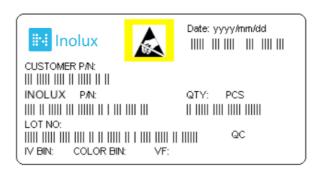


Ordering Information

Product	Emission Color	Technology	Test Current I _F (mA)	Luminous Intensity I _V (mcd) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number
	Red	AllnGaP	20	950	2.0	
IN-S126TBSRGB	Green	InGaN	20	1550	3.0	IN-S126TBSRGB
	Blue	InGaN	20	330	3.0	



Label Specifications



Inolux P/N:

ı	N	-	S	1	2	6	Т	В	S			R	G	В	-	-	-	-	-
			Material	Package Variation		Orientation	Current	Lens		Color				ustoi Stam					
	olux MD		S = PCB Type	126	TB = 3. T	2 x 1.5 ri-Chip		mm	S = Side View	(Blank) = 20mA	(Blank) = Clear	G:	=620n =526n =460n	m			-		

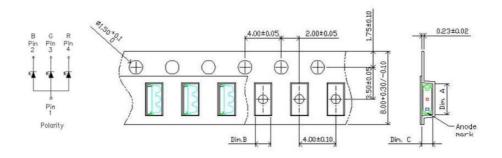
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Year (2017	2019 \	Month	Date	Serial	
Tracker		rear (2017)	, 2016,)	IVIOTILIT	Date	Seriai	



Packaging Information: 3000pcs Per Reel

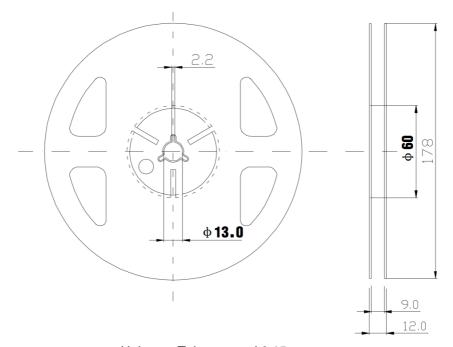
Tape Dimension



Dim. A	Dim. B	Dim. C	Q'ty/Reel
3.43±0.10	1.73±0.10	1.15±0.10	3K

Unit: mm Tolerance: +/-0.10 mm

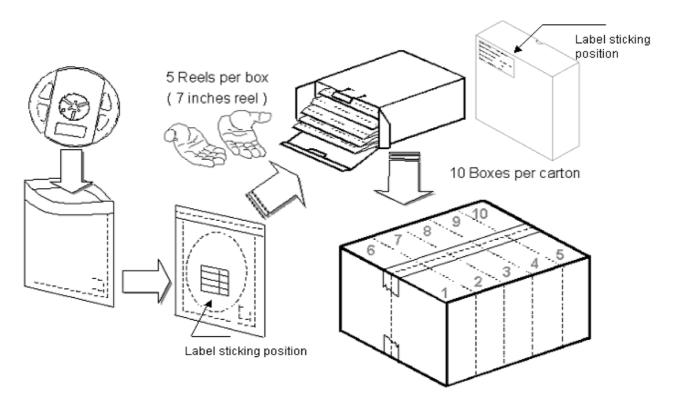
Reel Dimension



Unit: mm Tolerance: +/-0.15mm



Packing Dimension



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	3000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified
Othors			•

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

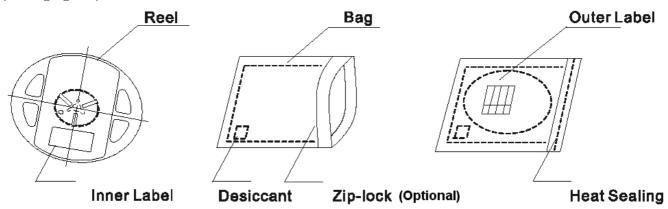


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

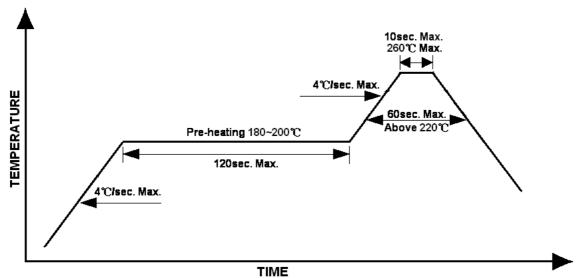
The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile





IN-S126TBSRGB Side View SMD LED 1206 PCB Type

Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



IN-S126TBSRGB Side View SMD LED 1206 PCB Type

Reliability

ltom	Frequency/ lots/ samples/	Standards	Conditions		
Item	failures	Reference			
	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs		
Precondition	monitoring tests according		2.) Moisture storage at 85°C/60% R.H. for		
	to JEDEC Level 2		168hrs		
	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155°C/ 24hrs		
Solderability		And CNS-5068	Tinning speed: 2.5+0.5cm/s		
			Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s		
		CNS-5067	Dipping soldering terminal only		
Resistance to			Soldering bath temperature		
soldering heat			A: 260+/-5°C; 10+/-1s		
			B: 350+/-10°C; 3+/-0.5s		
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs		
Operating life test			85°C/ 60%R.H. for 168hrs		
			2.) Tamb25°C; IF=20mA; duration 1000hrs		
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C		
high temperature			Humidity: 85% R.H., IF=5mA		
bias			Duration: 1000hrs		
High temperature	1Q/ 1/ 20	IN specs.	Tamb: 55°C		
bias			IF=20mA		
Dias			Duration: 1000hrs		
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty		
Pulse life test			cycle=0.125 (tp=125 μ s,T=1sec)		
			Duration 500hrs)		
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C		
Temperature		IEC 68-2-14, Nb	15min		
cycle			Thermal steady within 5 min		
Cycle			300 cycles		
			2 chamber/ Air-to-air type		
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C		
storage test			90+5/-10% R.H. for 500hrs		
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs		
storage test					
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs		
storage test					



IN-S126TBSRGB Side View SMD LED 1206 PCB Type

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	07-15-2019

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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.